

1825374-4

1825374-4 Information

Contraction to the second seco	Part Number Manufacturer Category Description Package	1825374-4 TE Connectivity AMP Connectors Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 16POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only		us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



1825374-4 Specifications

Manufacturer Part Number	1825374-4
Manufacturer	TE Connectivity AMP Connectors
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	Diplomate DL
Туре	DIP, 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	16 (2 x 8)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	15μin (0.38μm)
Contact Material - Mating	Phosphor Bronze
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	15μin (0.38μm)
Contact Material - Post	Phosphor Bronze
Housing Material	Thermoplastic, Glass Filled
Operating Temperature	-55°C ~ 125°C
	Report errors?

1825374-4 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.



If you have any question about 1825374-4, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com